

## 0.8A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

## **Features**

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automatic Assembly
- Miniature Package Saves Space on PC Boards
- Plastic Material: UL Flammability Classification Rating 94V-0
- UL Listed Under Recognized Component Index, File Number E94661

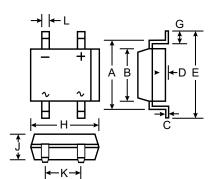
## **Mechanical Data**

Case: MiniDIP, Molded Plastic

 Terminals: Plated Leads, Solderable per MIL-STD-202, Method 2026

Polarity: As Marked on Case
Weight: 0.125 grams (approx.)

Marking: Type Number



MiniDIP					
Dim	Min	Max			
Α	5.43	5.75			
В	3.6	4.0			
С	0.15	0.35			
D	0.05	0.20			
E	_	7.0			
G	0.70	1.10			
Н	4.5	4.9			
J	2.3	2.7			
K	2.5	2.7			
L	0.50	0.80			
All Dimensions in mm					

## Maximum Ratings and Electrical Characteristics @ TA = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	HD01	HD02	HD04	HD06	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RMM</sub> V <sub>RWM</sub> V <sub>DC</sub>	100	200	400	600	V
RMS Reverse Voltage	V <sub>RMS</sub>	70	140	280	420	V
Average Forward Rectified Current (Note 1)  T <sub>A</sub> = @ 40°C	Io	0.8				А
Non-Repetitive Peak Forward Surge Current, 8.3 ms Single half-sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	30			А	
Instantaneous Voltage Drop @ 0.4A (per element)	V <sub>F</sub>	1.0			V	
Peak Reverse Current at Rated @ T <sub>A</sub> = 25°C DC Blocking Voltage (per element) @ T <sub>A</sub> = 125°C	I <sub>R</sub>	5.0 500			μА	
Typical Junction Capacitance (per element) (Note 2)	$C_{j}$	10			pF	
Typical Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	75				°C/W
Operating and Storage Temperature Range	$T_j$ , $T_{STG}$	-55 to +150			°C	

Notes: 1. Mounted on Ceramic PC Board.

2. Measured at 1.0 MHz and Applied Reverse Voltage of 4.0 V.

